ASOCIATION CONNECTING LECTRONICS INDUSTRIES® International and Pan	C. Bannockt	ourn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declara he declaration	tion of the sencompass	substances es all lowe	within the er level mat	manufacture erials for wh	er listed ite nich the ma	m. Note: i nufacture	if the item is an as r has engineering	sembly with lower responsibility.
				Form Type Distribute	*	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information			
Supplier Information														
Company name* Compa			ompany unique ID			Unique ID Authority					Response Date*			
onsemi											2024-05-04			
Contact Name Title - Contact				Pho			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product Env			nviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Rep			epresentative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product En			Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	ester Item Number Mfr Item Num		Number Mfr Item Name			Effective Da	e Versior	1	Manufacturing Site		W	eight*	UOM	Unit Type
	MC74H	MC74HC14ADG LOG CMOS S		HMITT TRG HEX		2024-05-04		-	PH1		12	2.04	mg	Each
Manufacturing Proccess Informat	ion					·					İ		· .	
Terminal Plating / Grid Array Ma	Terminal Plating / Grid Array Material Terminal Base Alloy			J-STD-020 MSI	ISL Rating Peak Process Body Temperature Max Time at Pe					ime at Peak	k Temperature Number of Reflow Cycles			
Matte Tin (Sn) - annealed CU Alloy				1		260		С	30		second	3		
Comments														
evel 1 - maximum time at peak temperatu	re during so	dering is 10-3	0 seconds											
or more information regarding material	omposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

select a RoHS exemption, if appli	cable [E] enter the weigh			ance category (JIG or Requester) or enter a [F] Optionally enter the positive (+) and n				
sigma range of distribution unless Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.98	mg	Supplier	Silicon (Si)	7440-21-3		0.98	mg
Die Attach	4.44	mg	Supplier	Silver (Ag)	7440-22-4		3.33	mg
			Supplier	Epoxy resins	129915-35-1		1.11	mg
Lead Frame 6	69.62	mg	Supplier	Silver (Ag)	7440-22-4		0.7658	mg
			Supplier	Zinc (Zn)	7440-66-6		0.1392	mg
			Supplier	Iron (Fe)	7439-89-6		1.8101	mg
			Supplier	Copper (Cu)	7440-50-8		66.9048	mg
Mold Compound-Black	43.43	mg		Epoxy resin	proprietary data		2.1715	mg
			Supplier	Phenolic Resin	Proprietary Data		2.1715	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.8686	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2172	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		38.0013	mg
Plating	3.27	mg	Supplier	Tin (Sn)	7440-31-5		3.27	mg
Wire Bond - Cu	0.3	mg	Supplier	Copper (Cu)	7440-50-8		0.3	mg